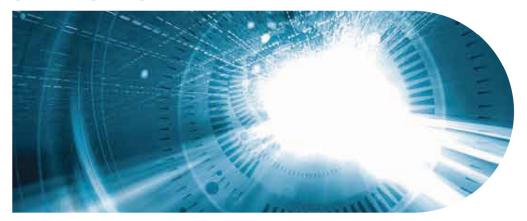
3SPTechnologiesSource of Smart Solutions





Active Components **Seed Laser Modules**

Key Features

Up to 500 mW operating power

Operating temperature up to 75 °C

1050-1070 nm wavelength range

Pulsed operation from 30 ns to 500 ns

Telcordia GR-468-CORE qualified

MTTF > 100.000h

RoHS 6/6

Applications

Fiber Lasers

Sensors

Raman spectroscopy

1064CHP

500 mW 1060 nm Cooled Seed Laser Module

The 1064CHP 1060 nm high power single-mode laser module is a seed source designed for both pulsed and CW fiber laser applications that require operating wavelengths in the 1050-1070 nm range, and can be used as a pump module as well.

This seed / pump module is powered by an in-house chip technology fully qualified, ensuring an outstanding level of performance, power consumption and reliability.

Low Profile, 14-pin butterfly modules are available with an operating power up to 500 mW CW and 1.2 W peak power.

They incorporate a thermoelectric cooler (TEC), a precision NTC thermistor and a back-facet monitoring photodiode.

Modules are available with a single mode Polarization Maintaining Fiber (PMF) pigtail.

The module meets the Telcordia™ GR-468-Core requirements for hermetic pump modules.





株式会社 光響

Email: info@symphotony.com Web: https://www.symphotony.com/

For more Info

Please contact us at: Europe & Asia: +33 169 805 750 North America: +1 514 748 4848, Ext

customerservice@3spgroup.com

500 mW 1060 nm **Cooled Seed / Pump Laser Module**







ELECTRO-OPTICAL CHARACTERISTICS

The following parameters are specified BOL for a T_{submount} = 25 °C, T_{case} = -5 °C to 75 °C, VBFM= -5 V and -50 dB max back-reflection unless otherwise stated.

| Parameters | Conditions | Symbol | Min | Тур | Max | Unit |
|--------------------------|---|------------------------|------------|------------|------|-------|
| PUMP LASER | | | | | ' | |
| Threshold current Note | | I _{th} | - | 60 | 80 | mA |
| Nominal operating power | @ 800 mA @ 1000 mA | P _{nom} | 400 500 | 420 525 | - | mW |
| Peak wavelength Note 2 | . P _{nom} | λρ | 1050 | - | 1070 | nm |
| Forward voltage | P _{nom} | V _{nom} | - | 1.6 | 2.0 | V |
| Operating peak power | <500 ns / 500 kHz | Popp | 0.9 | 1.0 | - | W |
| Operating peak current | <500 ns / 500 kHz | I _{opp} | - | - | 2 | Α |
| MONITOR DIODE | | | | | | |
| Responsivity | | dl _{BFM} / dP | 0.5 | _ | 10 | μΑ/mW |
| Dark current | V _r = 5 V | I _{BFM_dark} | - | 50 | 100 | nA |
| THERMO-ELECTRICAL COOLER | | | | | | |
| Cooling capacity | | ΔT _{TEC} | 50 | - | - | °C |
| TEC voltage (EOL) | T _{case} = 75 °C, 1.1 x I _{nom} | VTEC, EOL | - | - | 3.3 | V |
| TEC current (EOL) | T _{case} = 75 °C, 1.1 x I _{nom} | ITEC, EOL | - | - | 2.0 | Α |
| TEC power consumption | T _{case} = 75 °C, 1.1 x I _{nom} | PTEC | - | - | 5.05 | W |
| THERMISTOR | | | | | | |
| Resistance | 25 °C | R _{th} | 9.5 | 10 | 10.5 | kΩ |
| Constant | | β | 3600 | - | 4200 | K |

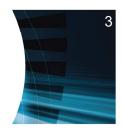
Note 1: I_{th} is the intersection point with the x-axis of a linear fit of the P(I) curve between 15 mW and 50 mW Note 2: Center Wavelength target upon customer request

3SP Technologies Datasheet www.3spgroup.com

500 mW 1060 nm Cooled Seed / Pump Laser Module







ABSOLUTE MAXIMUM RATINGS

Exposing this device to stresses and conditions above those listed in this section could cause permanent damage and affect reliability. The device is not meant to operate outside the operational limits described in previous section at any length of time.

| Parameter Conditions | Symbol | Min | Max | Unit |
|---|------------------------|-----|------|------|
| Storage temperature (2000 h) | T _{stg} | -40 | 85 | °C |
| Operating temperature (T _{submount} = 25 °C) | Top | -5 | 75 | °C |
| Lead soldering temperature (10 s maximum) | | - | 280 | °C |
| LD forward drive current (10 s maximum) | I _{f_max} | - | 1100 | mA |
| LD reverse voltage | V _{r_max} | - | 2.0 | V |
| PD reverse voltage | V _{PD_max} | - | 15 | V |
| PD forward current | I _{PD_max} | - | 10 | mA |
| TEC voltage | V _{TEC_C_max} | - | 4.2 | V |
| TEC current | ITEC_C_max | - | 2.0 | Α |
| ESD* damage | V _{ESD} | - | 500 | V |
| Mounting torque | | - | 150 | mN.m |
| Fiber bend radius | | 16 | - | mm |
| Axial pull force (1x1min) | | - | 5 | N |

^{*} Human Body model, C = 100 pF, R = 1.5 $k\Omega$

FIBER PIGTAIL CHARACTERISTICS

| Parameter | Note | Min | Тур | Max | Unit |
|----------------------------|------|-----------------------------------|-----|-----|------|
| Fiber type | | SM98-PS-U25A-H or equivalent | | | |
| Coating diameter | | 230 | 250 | 270 | μm |
| Loose tube buffer diameter | | 885 | - | 915 | μm |
| Fiber proof test level | | 200 | - | - | kpsi |
| Pigtail termination | | ferrule | | | |
| Polarization State | | Aligned parallel to the slow axis | | | |

3SP Technologies Datasheet www.3spgroup.com

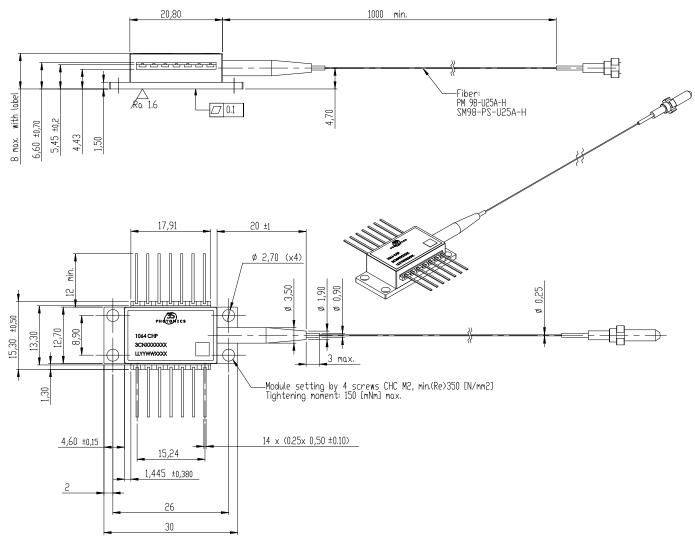
500 mW 1060 nm Cooled Seed / Pump Laser Module







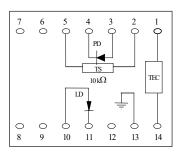
MECHANICAL DETAILS



Dimensions are in mm

PIN **ASSIGNEMENT**

| N° | Description | N° | Description |
|----|--------------------|----|-------------------|
| 1 | TEC (+) | 8 | No connect |
| 2 | Thermistor | 9 | No connect |
| 3 | Monitor PD Anode | 10 | Laser Anode (+) |
| 4 | Monitor PD Cathode | 11 | Laser Cathode (-) |
| 5 | Thermistor | 12 | No connect |
| 6 | No connect | 13 | Ground |
| 7 | No connect | 14 | TEC (-) |



Totally floating pin-out

3SP Technologies Datasheet www.3spgroup.com

500 mW 1060 nm Cooled Seed / Pump Laser Module







LASER SAFETY INFORMATION

This laser module emits invisible light. Take appropriate precautions to prevent undue exposure to naked eye when module is in operation. This product is classified Class 4 Laser Product according to IEC-60825-1.

HANDLING

This product is sensitive to electrostatic discharge and should not be handled except at a static free workstation. Take precautions to prevent ESD; use wrist straps, grounded work surfaces and recognized anti-static techniques when handling the pump laser module. Caution! Handle the module by its package only; never hold it by its pigtail. Care should be taken to avoid supply transient currents and voltages. Drive voltage above the maximum specified in absolute maximum rating section may cause permanent damage to the device.





APPLICATION NOTE

In order to prevent any mishandling, misuse, neglect or accident, it is highly recommended to read and follow the instructions detailed in the application note:

RCL IMA APN 000 00007 "Handling, Mounting, Testing and Operating Cooled 14-pin Butterfly Laser Pumps"

ORDERING INFORMATION

1064CHP 1060 NM PUMP PRODUCT FAMILY

| | • | | |
|---------------|------------------------------------|--|--|
| PMF pigtail | λ _p = 1060 nm, T= 25 °C | | |
| Nominal Power | Part Number | | |
| 400 mW | 3CN01341DA | | |
| 500 mW | 3CN01341EA | | |

3SP Technologies can also develop custom products to meet a wide range of technical requirements. Please contact your Sales Manager for details.

3SP Technologies Datasheet www.3spgroup.com

500 mW 1060 nm Cooled Seed / Pump Laser Module







CONTACT INFORMATION

Please contact us at:

Europe & Asia: +33 169 805 750

North America: +1 514 748 4848, Ext 4374

customerservice@3spgroup.com www.3sptechnologies.com

IMPORTANT NOTICE

Information in this document is typical and must be specifically confirmed in writing by your supplier before it becomes applicable to any order or contract.

Information is subject to change without notice.

©2019 3SP Technologies S.A.S.

